

1752-2 1.1

Material Composition Declaration

© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.

This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Form Type* Distribute Declaration Class* Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infomation

Supplier Information							
Company Name *	Company Unique ID	Unique ID Authority	Response Date*				
Fairchild Semiconductor	00-489-5751	Dun & Bradstreet	Sat, Jul 27, 2013 02:20 AM				
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *				
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com				
Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *				
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com				

Requester Item Number	Mfr I	em Number	Mfr Item Name		Effective Date	Version		Manufacturing Site	Weight*	UOM	Unit Type
FAN6921AMLMY	FAN6921AMLMY FAN6921AMLMY		SOIC-16 (AgLF)	(G) SU		SUE	BCONTRACTOR	0.147792	g	Each	
Manufacturing Process Information											
Terminal Finish	Base Alloy	J-STD-02	0 MSL Rating Pe		Peak Process Body Temperature		Max Time at Peak Temperature		No Reflow cycles		
Matte Tin (Sn)	CU Alloy		3		260 C		30 seconds			3	

* Required Field

www.BDTIC.com/FAIRCHILD

RoHS Material (Composition Declaration	Declaration Type * Custom						
RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, RoHS Directive							
restriction of the	Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the cou use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this docun irchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.							
ensure our production independently ver	nber listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairch ets are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's produc rified regarding substance content. In the event of any issues arising from information in this document, the warranty d conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.	ts may have been						
Safety Data Sheet miniscule quantit	the content disclosed herewith is approximate and is based on various methods including, engineering calculations, its, analytical measurements. Fairchild may update this document without notification. This statement may not including of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed contain alternate substances of similar composition.	le information regarding the						
RoHS Declaration	* 1 - Item(s) does not contain RoHS restricted substances per the definition above Sup	plier Acceptance * Accepted						
1 1	ne declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exer ponse in the RoHS Declaration above and choose all applicable exemptions.	nptions, then select the						
Exemption None	List Version EL-2011/534/EU							
Declaration Signa	ature							

David Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

www.BDTIC.com/FAIRCHILD

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name SOIC-16 (AgLF) (G)

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	4.350	Supplier		Silicon	4.350	7440-21-3	29433
Die Attach	Other Organic Materials	0.440	Supplier		Acrylic Resin	0.095	54208-63-8	640
			Supplier		Silver	0.345	7440-22-4	2334
Encapsulation	Thermoplastics	93.900	Supplier		Carbon Black	0.939	1333-86-4	6354
			Supplier		Epoxy Resin	18.780	29690-82-2	127071
			Supplier		Silica, vitreous	74.181	60676-86-0	501930
Lead Frame	Copper & its alloys	46.395	Supplier		Copper	45.000	7440-50-8	304483
			Supplier		Iron	1.110	7439-89-6	7511
			Supplier		Phosphorus	0.019	7723-14-0	126
			Supplier		Silver	0.206	7440-22-4	1394
			Supplier		Zinc	0.060	7440-66-6	408
Plating	Other Nonferrous metals & alloys	2.310	Supplier		Tin	2.310	7440-31-5	15630
Wire Bond	Precious metals	0.397	Supplier		Gold	0.397	7440-57-5	2686

www.BDTIC.com/FAIRCHILD